

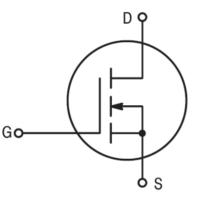
Rev. V1

The RF MOSFET Line: Broadband RF Power FET 5.0W, to 400MHz, 28V

Designed for wideband large-signal amplifier and oscillator applications up to 400 MHz range.

N-Channel enhancement mode

- Guaranteed 28V, 150 MHz performance . Output power = 5.0 watts Minimum gain = 11 dB Efficiency = 55% (Typical)
- Small- and large-signal characterization •
- Typical performance at 400 MHz, 28V, 5.0W . Output = 10.6 dB gain
- 100% tested for load mismatch at all phase angles with 30:1 VSWR •
- Low noise figure: 2.0 dB (Typ.) at 200 mA, 150 MHz •
- Excellent thermal stability, ideally suited for Class A operation •



MAXIMUM RATINGS

Rating	Symbol 3 -	Value	Unit
Drain–Source Voltage	V _{DSS}	65	Vdc
Drain–Gate Voltage (R _{GS} = 1.0 MΩ)	V _{DGR}	65	Vdc
Gate-Source Voltage	V _{GS}	±40	Vdc
Drain Current — Continuous	Ι _D	0.9	Adc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	PD	17.5 0.1	Watts W/°C
Storage Temperature Range	T _{stg}	-65 to +150	°C

THERMAL CHARACTERISTICS

Rating		Value	Unit
Thermal Resistance, Junction to Case	R _{θJC}	10	°C/W

Handling and Packaging - MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

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Product Image



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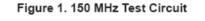
ELECTRICAL CHARACTERISTICS	(T _C = 25°C unless otherwise noted.)
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Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS		•			•
Drain–Source Breakdown Voltage (V _{GS} = 0, I _D = 5.0 mA)	V(BR)DSS	65	_	_	Vdc
Zero Gate Voltage Drain Current (V _{DS} = 28 V, V _{GS} = 0)	I _{DSS}	_	_	1.0	mAdc
Gate-Source Leakage Current (V _{GS} = 20 V, V _{DS} = 0)	I _{GSS}	_	_	1.0	μAdc
ON CHARACTERISTICS					
Gate Threshold Voltage (I_D = 10 mA, V_{DS} = 10 V)	V _{GS(th)}	1.0	3.5	6.0	Vdc
Forward Transconductance (V_{DS} = 10 V, I_D = 100 mA)	9fs	80	110	—	mmhos
DYNAMIC CHARACTERISTICS		1			1
Input Capacitance (V _{DS} = 28 V, V _{GS} = 0, f = 1.0 MHz)	C _{iss}	_	7.0	—	pF
Output Capacitance (V_{DS} = 28 V, V_{GS} = 0, f = 1.0 MHz)	C _{oss}	_	9.7	—	pF
Reverse Transfer Capacitance (V _{DS} = 28 V, V _{GS} = 0, f = 1.0 MHz)	C _{rss}	_	2.3	_	pF
FUNCTIONAL CHARACTERISTICS					
Noise Figure (V _{DS} = 28 Vdc, I _D = 200 mA, f = 150 MHz)	NF	-	2.0	—	dB
Common Source Power Gain (V _{DD} = 28 Vdc, P _{out} = 5.0 W, I _{DQ} = 50 mA)	G _{ps}				dB
f = 150 MHz (Fig. 1) f = 400 MHz (Fig. 14)		11	14 10.6	_	
Drain Efficiency (Fig. 1) (V _{DD} = 28 Vdc, P _{out} = 5.0 W, f = 150 MHz, I _{DQ} = 50 mA)	η	50	55	_	%
Electrical Ruggedness (Fig. 1) (V _{DD} = 28 Vdc, P _{out} = 5.0 W, f = 150 MHz, I _{DQ} = 50 mA, VSWR 30:1 at all Phase Angles)	Ψ	No Degradation in Output Power			

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R3* R4 V_{DD} = 28 V C10 C11 n C7 C9 C12 C8 R5 1.3 R2 Ŧ C5 C6 C4 RF OUTPUT R1 L2 ÷ 1.1 RF INPUT €Сз الر 1 DUT 0 C2 *Bias Adjust C1, C4 - Arco 406, 15-115 pF L3 - 20 Turns, #20 AWG Enamel Wound on R5 C2 — Arco 403, 3.0–35 pF C3 — Arco 402, 1.5–20 pF L4 — Ferroxcube VK-200 — 19/4B R1 - 68 Ω, 1.0 W Thin Film C5, C6, C7, C8, C12 - 0.1 µF Erie Redcap R2 - 10 kΩ, 1/4 W C9 - 10 µF, 50 V R3 - 10 Turns, 10 kΩ Beckman Instruments 8108 C10, C11 - 680 pF Feedthru R4 — 1.8 kΩ, 1/2 W D1 — 1N5925A Motorola Zener R5 - 1.0 MΩ. 2.0 W Carbon L1 - 3 Turns, 0.310" ID, #18 AWG Enamel, 0.2" Long Board - G10, 62 mils L2 - 3-1/2 Turns, 0.310" ID, #18 AWG Enamel, 0.25" Long



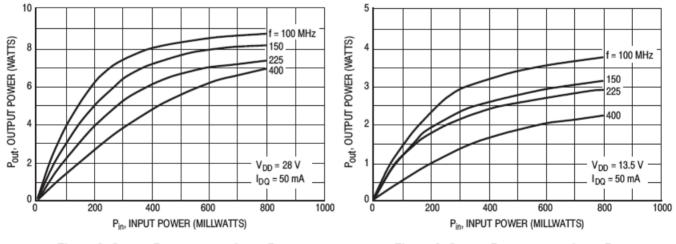


Figure 2. Output Power versus Input Power

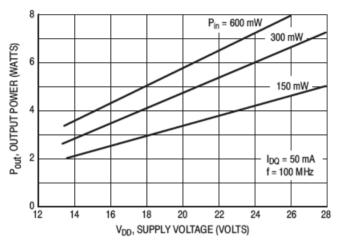


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8 P_{in} = 800 mW Pout, OUTPUT POWER (WATTS) 400 mW 6 200 mW I_{DQ} = 50 mA 2 f = 150 MHz 0 L 12 14 16 18 20 22 24 26 28 VDD, SUPPLY VOLTAGE (VOLTS)

Figure 4. Output Power versus Supply Voltage

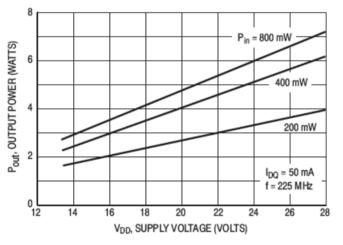


Figure 6. Output Power versus Supply Voltage

Figure 5. Output Power versus Supply Voltage

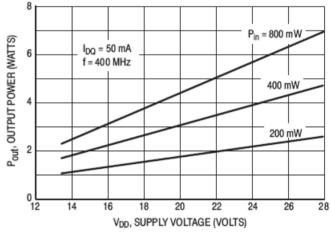


Figure 7. Output Power versus Supply Voltage

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0.96

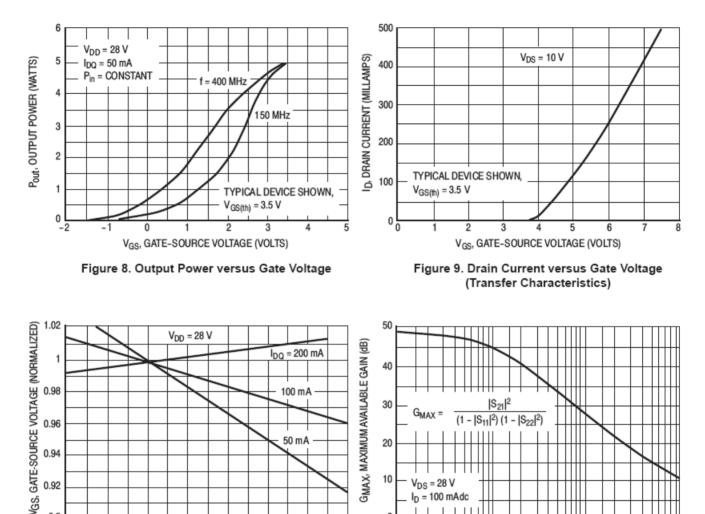
0.94

0.92



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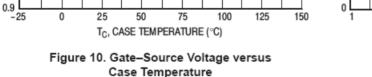
G_{MAX} =

V_{DS} = 28 V

I_D = 100 mAdc

20

10



50 m A



f, FREQUENCY (MHz)

100

1000

(1 - |S11|2) (1 - |S22|2)

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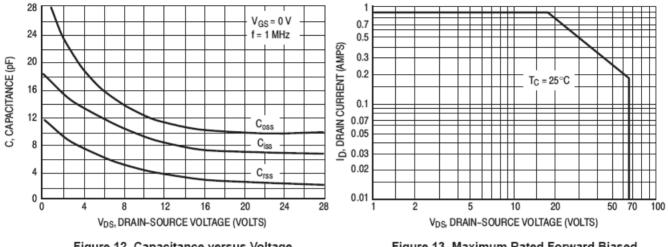
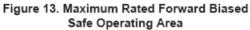
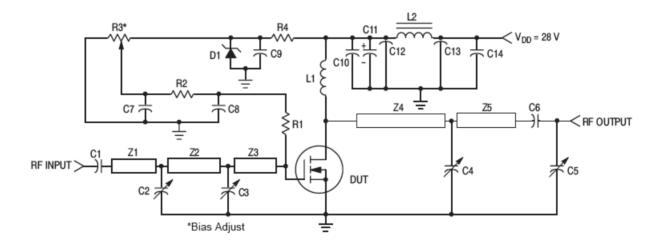


Figure 12. Capacitance versus Voltage





- C1, C6 270 pF, ATC 100 mils C2, C3, C4, C5 — 0–20 pF Johanson C7, C9, C10, C14 — 0.1 μ F Erie Redcap, 50 V C8 — 0.001 μ F C11 — 10 μ F, 50 V C12, C13 — 680 pF Feedthru D1 — 1N5925A Motorola Zener L1 — 6 Turns, 1/4" ID, #20 AWG Enamel L2 — Ferroxcube VK–200 — 19/4B R1 — 68 Ω , 1.0 W Thin Film
- $\begin{array}{l} \text{R2} & = 10 \ \text{k}\Omega, \ 1/4 \ \text{W} \\ \text{R3} & = 10 \ \text{Turns}, \ 10 \ \text{k}\Omega \ \text{Beckman Instruments} \ 8108 \\ \text{R4} & = 1.8 \ \text{k}\Omega, \ 1/2 \ \text{W} \\ \text{Z1} & = 1.4^{\prime\prime} \ x \ 0.166^{\prime\prime} \ \text{Microstrip} \\ \text{Z2} & = 1.1^{\prime\prime} \ x \ 0.166^{\prime\prime} \ \text{Microstrip} \\ \text{Z3} & = 0.95^{\prime\prime} \ x \ 0.166^{\prime\prime} \ \text{Microstrip} \\ \text{Z4} & = 2.2^{\prime\prime} \ x \ 0.166^{\prime\prime} \ \text{Microstrip} \\ \text{Z5} & = 0.85^{\prime\prime} \ x \ 0.166^{\prime\prime} \ \text{Microstrip} \\ \text{Board} & = \text{Glass Teflon, \ 62 mils} \end{array}$

Figure 14. 400 MHz Test Circuit

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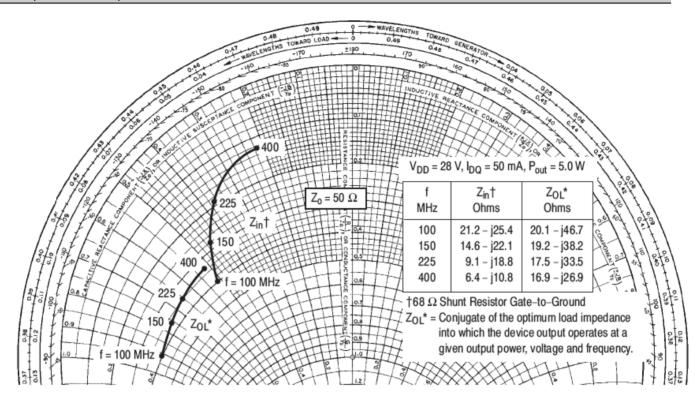


Figure 15. Large–Signal Series Equivalent Input/Output Impedances, Z_{in}⁺, Z_{OL}*

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The RF MOSFET Line: Broadband RF Power FET 5.0W, to 400MHz, 28V

f	\$ ₁₁		\$ ₂₁		\$ ₁₂		\$ ₂₂	
(MHz)	S ₁₁	∠¢	S ₂₁	$\angle \phi$	S ₁₂	$\angle \phi$	S ₂₂	∠¢
1.0	0.989	-1.0	11.27	179	0.0014	89	0.954	-1.0
2.0	0.989	-2.0	11.27	179	0.0028	89	0.954	-2.0
5.0	0.988	-5.0	11.26	176	0.0069	86	0.954	-4.0
10	0.985	-10	11.20	173	0.014	83	0.951	-9.0
20	0.977	-20	10.99	166	0.027	76	0.938	-18
30	0.965	-30	10.66	159	0.039	69	0.918	-26
40	0.950	-39	10.25	153	0.051	63	0.895	-34
50	0.931	-47	9.777	147	0.060	57	0.867	-42
60	0.912	-53	9.359	142	0.069	53	0.846	-49
70	0.892	-58	8.960	138	0.077	49	0.828	-56
80	0.874	-62	8.583	135	0.085	46	0.815	-62
90	0.855	-66	8.190	131	0.091	43	0.801	-68
100	0.833	-70	7.808	128	0.096	40	0.785	-74
110	0.827	-73	7.661	125	0.101	38	0.784	-77
120	0.821	-76	7.515	122	0.107	36	0.784	-82
130	0.814	-79	7.368	119	0.113	34	0.784	-85
140	0.808	-82	7.222	116	0.119	32	0.783	-88
150	0.802	-86	7.075	114	0.125	31	0.783	-90
160	0.788	-89	6.810	112	0.127	30	0.780	-92
170	0.774	-92	6.540	110	0.128	28	0.774	-94
180	0.763	-94	6.220	108	0.130	26	0.762	-98
190	0.751	-97	5.903	106	0.132	24	0.760	-100
200	0.740	-100	5.784	104	0.134	23	0.758	-103
225	0.719	-104	5.334	100	0.136	20	0.757	-107
250	0.704	-108	4.904	97	0.139	19	0.758	-110
275	0.687	-113	4.551	92	0.141	16	0.757	-114
300	0.673	-117	4.219	89	0.141	14	0.750	-117
325	0.668	-120	3.978	86	0.142	12	0.757	-120
350	0.669	-123	3.737	83	0.142	10	0.766	-121
375	0.662	-125	3.519	80	0.143	9.0	0.768	-123
400	0.654	-127	3.325	77	0.142	8.0	0.772	-124
425	0.650	-129	3.170	75	0.140	7.0	0.772	-125
450	0.638	-131	3.048	72	0.141	6.0	0.783	-125
475	0.614	-132	2.898	71	0.136	6.0	0.786	-126
500	0.641	-133	2.833	68	0.136	5.0	0.795	-127
525	0.638	-135	2.709	66	0.135	5.0	0.801	-127
550	0.633	-137	2.574	64	0.133	4.0	0.802	-128
575	0.628	-138	2.481	62	0.131	5.0	0.805	-128
600	0.625	-140	2.408	60	0.129	5.0	0.814	-128

The Power RF characterization data were measured with a 68 ohm resistor shunting the MRF134 input port. The scattering parameters were measured on the MRF134 device alone with no external components.

(continued)

Table 1. Common Source Scattering Parameters V_{DS} = 28 V, I_D = 100 mA

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f (MHz)	\$ ₁₁		\$ ₂₁		\$ ₁₂		\$ ₂₂	
	S ₁₁	$\angle \phi$	\$ ₂₁	$\angle \phi$	S ₁₂	$\angle \phi$	\$ ₂₂	∠¢
625	0.619	-142	2.334	58	0.128	5.0	0.818	-129
650	0.617	-144	2.259	56	0.125	6.0	0.824	-130
675	0.618	-146	2.192	55	0.123	7.0	0.834	-130
700	0.619	-147	2.124	53	0.122	8.0	0.851	-131
725	0.618	-150	2.061	51	0.120	9.0	0.859	-132
750	0.614	-152	1.983	49	0.118	11	0.857	-133
775	0.609	-154	1.908	48	0.119	13	0.865	-133
800	0.562	-155	1.877	49	0.118	15	0.872	-133
825	0.587	-156	1.869	46	0.119	16	0.869	-134
850	0.593	-158	1.794	44	0.118	18	0.875	-135
875	0.597	-160	1.749	43	0.119	18	0.881	-135
900	0.598	-162	1.700	41	0.118	18	0.889	-136
925	0.592	-164	1.641	40	0.115	18	0.888	-138
950	0.588	-166	1.590	39	0.112	20	0.877	-138
975	0.586	-168	1.572	39	0.108	23	0.864	-137
1000	0.590	-171	1.551	37	0.107	28	0.863	-137

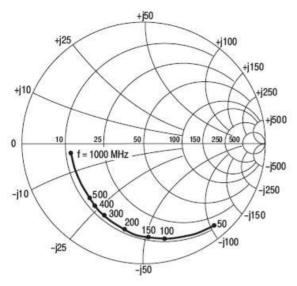
The Power RF characterization data were measured with a 68 ohm resistor shunting the MRF134 input port. The scattering parameters were measured on the MRF134 device alone with no external components.

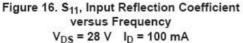
Table 1. Common Source Scattering Parameters (continued) V_{DS} = 28 V, I_D = 100 mA

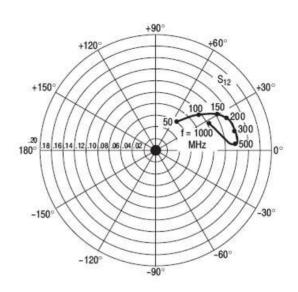
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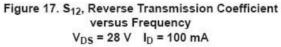


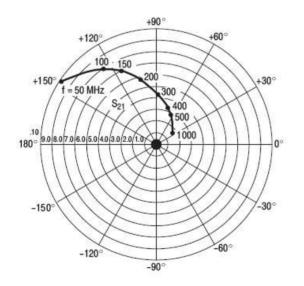
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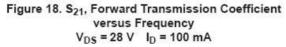


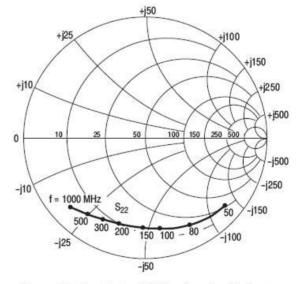


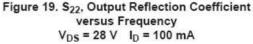












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RF POWER MOSFET CONSIDERATIONS

DESIGN CONSIDERATIONS

The MRF137 is a RF power N–Channel enhancementmode field–effect transistor (FET) designed especially for VHF power amplifier applications. M/A-COM RF MOS FETs feature a vertical structure with a planar design, thus avoiding the processing difficulties associated with V–groove vertical power FETs.

M/A-COM Application Note AN211A, FETs in Theory and Practice, is suggested reading for those not familiar with the construction and characteristics of FETs.

The major advantages of RF power FETs include high gain, low noise, simple bias systems, relative immunity from thermal runaway, and the ability to withstand severely mismatched loads without suffering damage. Power output can be varied over a wide range with a low power dc control signal, thus facilitating manual gain control, ALC and modulation.

DC BIAS

The MRF137 is an enhancement mode FET and, therefore, does not conduct when drain voltage is applied. Drain current flows when a positive voltage is applied to the gate. See Figure 10 for a typical plot of drain current versus gate voltage. RF power FETs require forward bias for optimum performance.

The value of quiescent drain current (IDQ) is not critical formany applications. The MRF137 was characterized at IDQ = 25 mA, which is the suggested minimum value of IDQ. For special applications such as linear amplification, IDQ may have to be selected to optimize the critical parameters.

The gate is a dc open circuit and draws no current. Therefore, the gate bias circuit may generally be just a simple

resistive divider network. Some special applications may require a more elaborate bias system. **GAIN CONTROL**

Power output of the MRF137 may be controlled from its rated value down to zero (negative gain) by varying the dc gate voltage. This feature facilitates the design of manual gain control, AGC/ALC and modulation systems. (See Figure 9.)

AMPLIFIER DESIGN

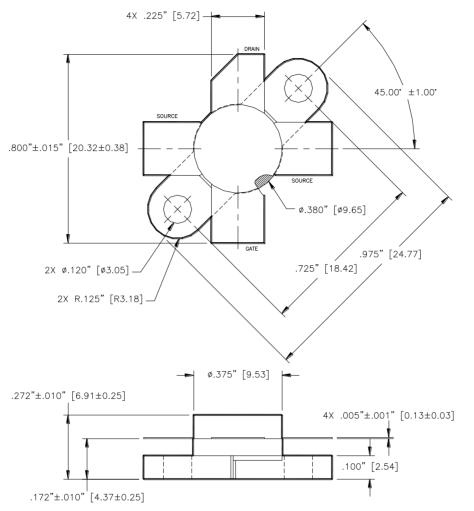
Impedance matching networks similar to those used with bipolar VHF transistors are suitable for MRF137. See M/A-COM Application Note AN721, Impedance Matching Networks Applied to RF Power Transistors. The higher input impedance of RF MOS FETs helps ease the task of broadband network design. Both small signal scattering parameters and large signal impedances are provided. While the sparameters will not produce an exact design solution for high power operation, they do yield a good first approximation. This is an additional advantage of RF MOS power FETs.

RF power FETs are triode devices and, therefore, not unilateral. This, coupled with the very high gain of the MRF137, yields a device capable of self oscillation. Stability may be achieved by techniques such as drain loading, input shunt resistive loading, or output to input feedback. Two port parameter stability analysis with the MRF137 s-parameters provides a useful tool for selection of loading or feedback circuitry to assure stable operation. See M/A-COM Application Note AN215A for a discussion of two port network theory and stability.

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